

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









3.0x1.0mm RIGHT ANGLE SMD CHIP LED **LAMP**



ATTENTION

OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES**

Part Number: APFA3010LSEKJ3ZGKQBC

Hyper Red Green Blue

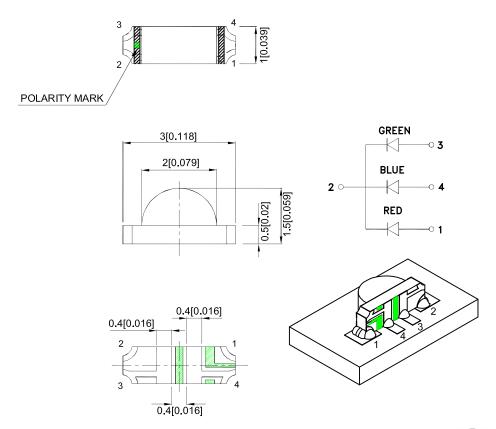
Features

- 3.0mmx1.5mmx1.0mm right angle SMD LED, 1.0mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability.
- Low current IF=2mA operating.
- RoHS compliant.

Descriptions

- The Hyper Red device is based on light emitting diode chip made from AlGaInP.
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.
- The Blue source color devices are made with InGaN Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

Package Dimensions



SPEC NO: DSAO4458

APPROVED: Wynec

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.2(0.008") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

REV NO: V.2B DATE: SEP/18/2015 PAGE: 1 OF 7 **CHECKED: Allen Liu** DRAWN: F.T.Liu ERP: 1203015164

Selection Guide

Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 2mA		Viewing Angle [1]
			Min.	Тур.	201/2
APFA3010LSEKJ3ZGKQBC	Hyper Red (AlGaInP)		20	40	120°
	Green (InGaN)	Water Clear	20	60	
	Blue (InGaN)		4	10	

Notes:

- 1.01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2.Luminous intensity / luminous Flux: +/-15%.
 3.Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Green Blue	640 515 460		nm	Ir=2mA
λD [1]	Dominant Wavelength	Hyper Red Green Blue	625 525 465		nm	Ir=2mA
Δλ1/2	Spectral Line Half-width	Hyper Red Green Blue	20 35 25		nm	Ir=2mA
С	Capacitance	Hyper Red Green Blue	27 45 100		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red Green Blue	1.8 2.65 2.65	2.1 3.1 3.1	V	Ir=2mA
lR	Reverse Current	Hyper Red Green Blue		10 50 50	uA	VR=5V

Notes:

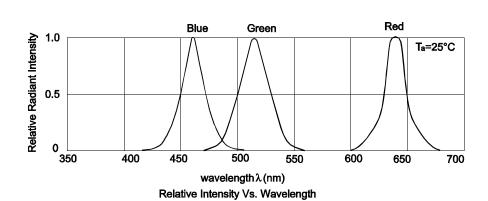
- 1.Wavelength: +/-1nm. 2.Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
- 4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

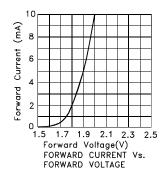
Parameter	Hyper Red	Green	Blue	Units	
Power dissipation	63	77.5	93	mW	
DC Forward Current	30	25	30	mA	
Peak Forward Current [1]	150	150	150	mA	
Electrostatic Discharge Threshold (HBM)	3000	450	250	V	
Reverse Voltage		V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

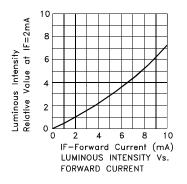
Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

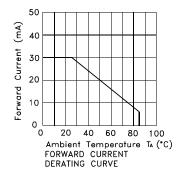
SPEC NO: DSAO4458 **REV NO: V.2B DATE: SEP/18/2015** PAGE: 2 OF 7 APPROVED: Wynec **CHECKED: Allen Liu** DRAWN: F.T.Liu ERP: 1203015164

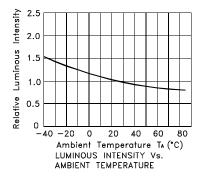


APFA3010LSEKJ3ZGKQBC Hyper Red



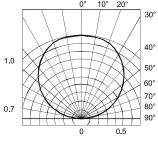






PAGE: 3 OF 7

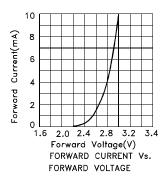
ERP: 1203015164

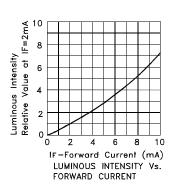


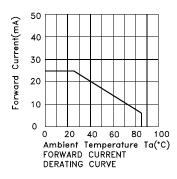
SPATIAL DISTRIBUTION

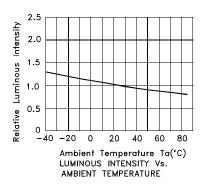
SPEC NO: DSAO4458 REV NO: V.2B DATE: SEP/18/2015
APPROVED: Wynec CHECKED: Allen Liu DRAWN: F.T.Liu

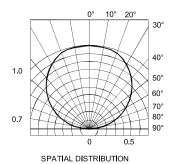
Green







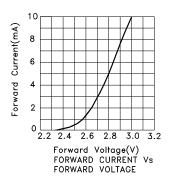


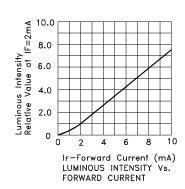


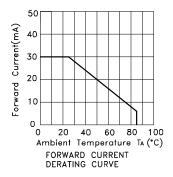
SPEC NO: DSAO4458 APPROVED: Wynec REV NO: V.2B CHECKED: Allen Liu DATE: SEP/18/2015 DRAWN: F.T.Liu PAGE: 4 OF 7

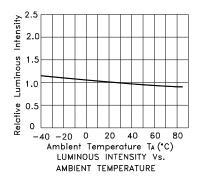
ERP: 1203015164

Blue



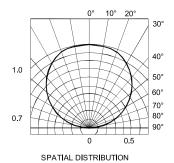






PAGE: 5 OF 7

ERP: 1203015164

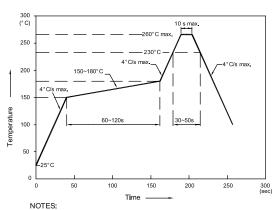


SPEC NO: DSAO4458 REV NO: V.2B DATE: SEP/18/2015
APPROVED: Wynec CHECKED: Allen Liu DRAWN: F.T.Liu

APFA3010LSEKJ3ZGKQBC

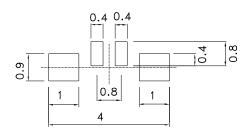
Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature
- to high temperature.
 3.Number of reflow process shall be 2 times or less.

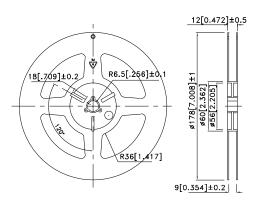
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

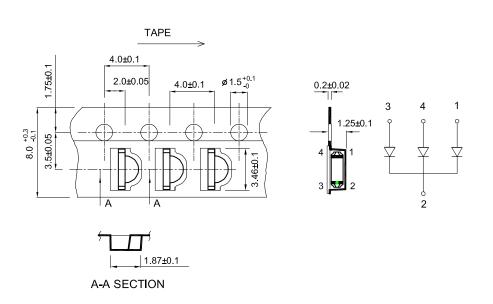


Tape Dimensions

(Units: mm)

Reel Dimension

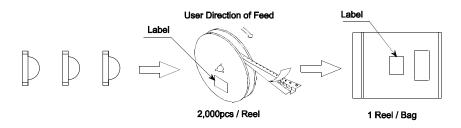


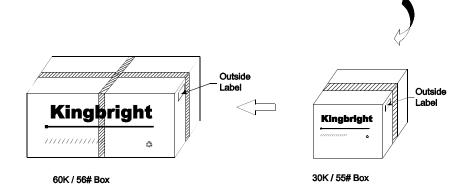


SPEC NO: DSAO4458 APPROVED: Wynec REV NO: V.2B CHECKED: Allen Liu DATE: SEP/18/2015 DRAWN: F.T.Liu PAGE: 6 OF 7 ERP: 1203015164

PACKING & LABEL SPECIFICATIONS

APFA3010LSEKJ3ZGKQBC







Terms and conditions for the usage of this document

- 1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- 2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- 3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
- 4. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
- 5. The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright.
- 6. All design applications should refer to Kingbright application notes available at http://www.KingbrightUSA.com/ApplicationNotes

 SPEC NO: DSAO4458
 REV NO: V.2B
 DATE: SEP/18/2015
 PAGE: 7 OF 7

 APPROVED: Wynec
 CHECKED: Allen Liu
 DRAWN: F.T.Liu
 ERP: 1203015164